

### Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
<b>Characteristic</b>				
IGBT thermal resistance, junction – case	$R_{thJC}$		0.33	K/W
Diode thermal resistance, junction – case	$R_{thJCD}$		0.33	
Thermal resistance, junction – ambient	$R_{thJA}$		40	

### Electrical Characteristic, at $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	Typ.	max.	
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0V, I_C=0.5mA$	900	-	-	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{GE} = 15V, I_C=30A$ $T_j=25^{\circ}C$ $T_j=150^{\circ}C$ $T_j=175^{\circ}C$	- - -	1.5 1.6 1.7	1.7 - -	
Diode forward voltage	$V_F$	$V_{GE}=0V, I_F=30A$ $T_j=25^{\circ}C$ $T_j=150^{\circ}C$ $T_j=175^{\circ}C$	- - -	1.4 1.4 1.45	1.6 - -	
Gate-emitter threshold voltage	$V_{GE(th)}$	$I_C=700\mu A, V_{CE}=V_{GE}$	5.1	5.8	6.4	
Zero gate voltage collector current	$I_{CES}$	$V_{CE}=900V, V_{GE}=0V$ $T_j=25^{\circ}C$ $T_j=150^{\circ}C$	- -	- -	5 2500	$\mu A$
Gate-emitter leakage current	$I_{GES}$	$V_{CE}=0V, V_{GE}=20V$	-	-	600	
						nA

### Dynamic Characteristic

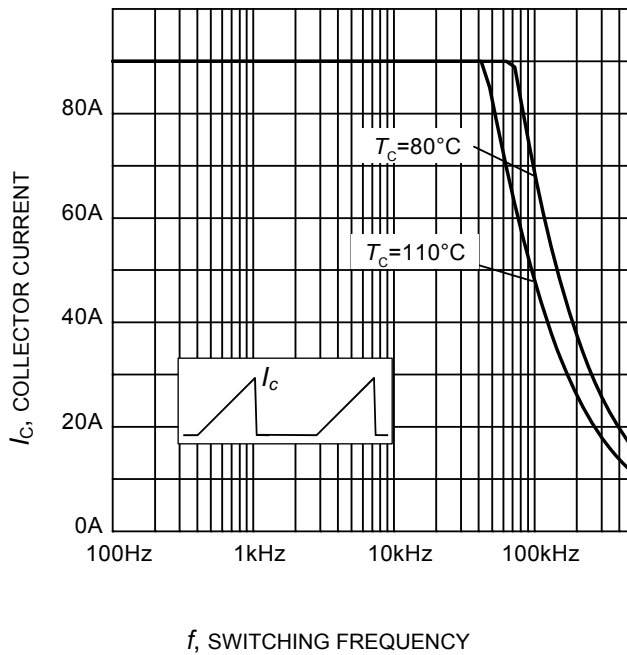
Input capacitance	$C_{iss}$	$V_{CE}=25V,$ $V_{GE}=0V,$ $f=1MHz$	-	2889	-	pF
Output capacitance	$C_{oss}$		-	83	-	
Reverse transfer capacitance	$C_{rss}$		-	79	-	
Gate charge	$Q_{Gate}$	$V_{CC}=720V, I_C=30A$ $V_{GE}=15V$	-	200	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	$L_E$		-	13	-	nH

### Switching Characteristic, Inductive Load, at $T_j=25^\circ C$

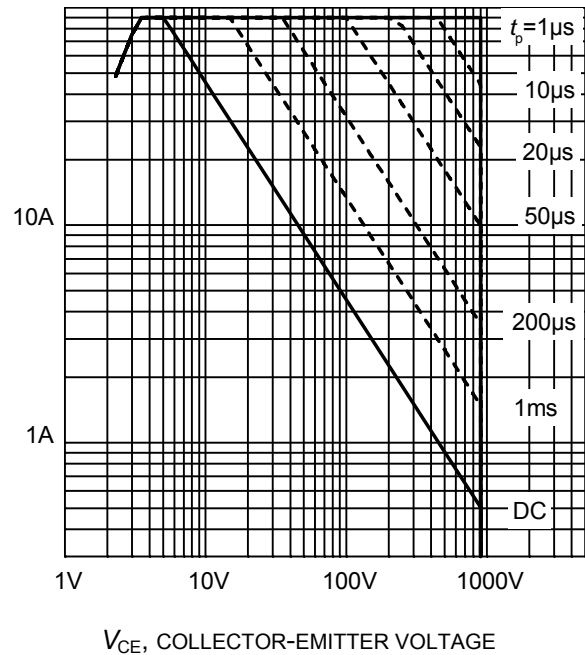
Parameter	Symbol	Conditions	Value			Unit
			min.	Typ.	Max.	
IGBT Characteristic						
Turn-off delay time	$t_{d(off)}$	$T_j=25^{\circ}C$ $V_{CC}=600V,$ $I_C=30A,$ $V_{GE}=0/15V,$ $R_G=15\Omega$	-	511	-	mJ
Fall time	$t_f$		-	24	-	
Turn-on energy	$E_{on}$		-	-	-	
Turn-off energy	$E_{off}$		-	1.46	-	
Total switching energy	$E_{ts}$		-	1.46	-	

### Switching Characteristic, Inductive Load, at $T_j=175^\circ C$

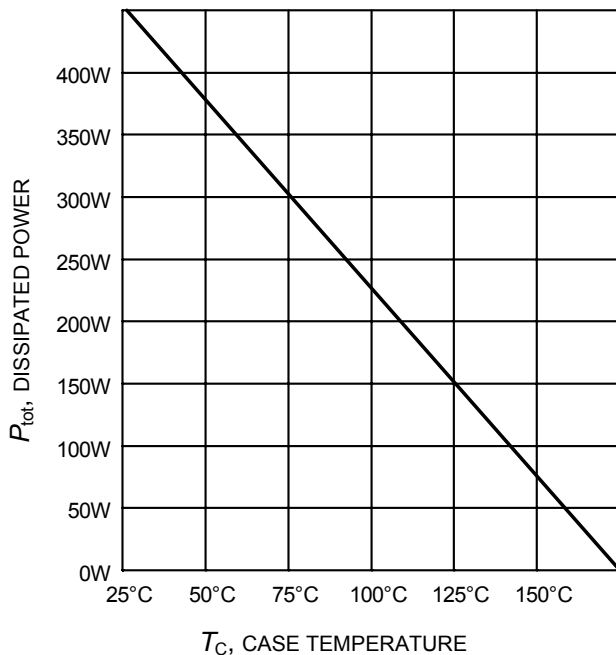
Parameter	Symbol	Conditions	Value			Unit
			min.	Typ.	max.	
IGBT Characteristic						
Turn-off delay time	$t_{d(off)}$	$T_j=175^{\circ}C$ $V_{CC}=600V,$ $I_C=30A,$ $V_{GE}=0/15V,$ $R_G=15\Omega$	-	594	-	mJ
Fall time	$t_f$		-	46	-	
Turn-on energy	$E_{on}$		-	-	-	
Turn-off energy	$E_{off}$		-	2.1	-	
Total switching energy	$E_{ts}$		-	2.1	-	



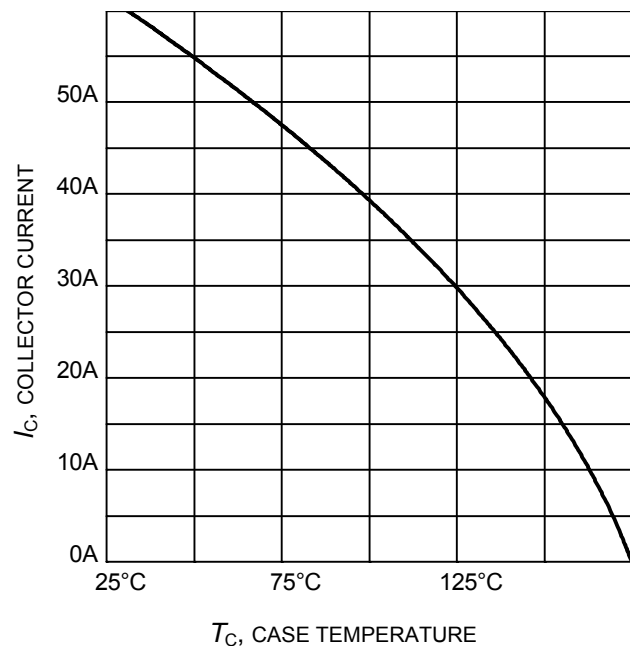
**Figure 1. Collector current as a function of switching frequency for triangular current ( $E_{on} = 0$ , hard turn-off)**  
 $(T_j \leq 175^\circ\text{C}, D = 0.5, V_{CE} = 600\text{V}, V_{GE} = 0/+15\text{V}, R_G = 15\Omega)$



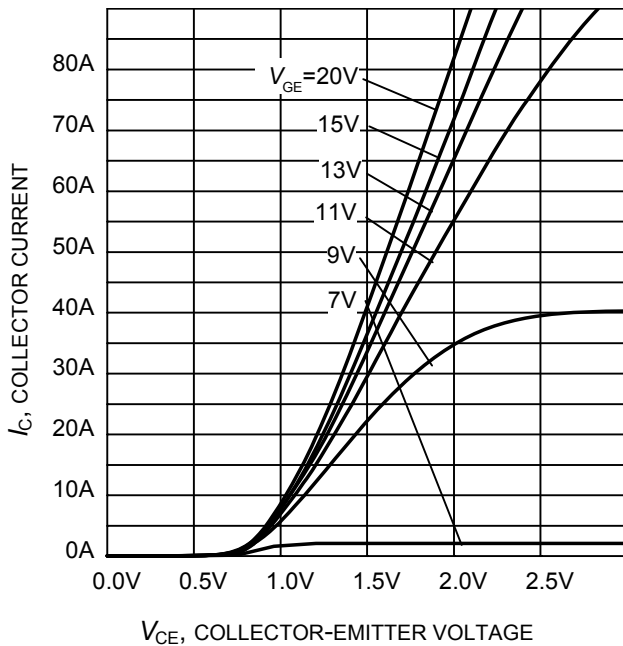
**Figure 2. IGBT Safe operating area**  
 $(D = 0, T_C = 25^\circ\text{C}, T_j \leq 175^\circ\text{C}; V_{GE} = 15\text{V})$



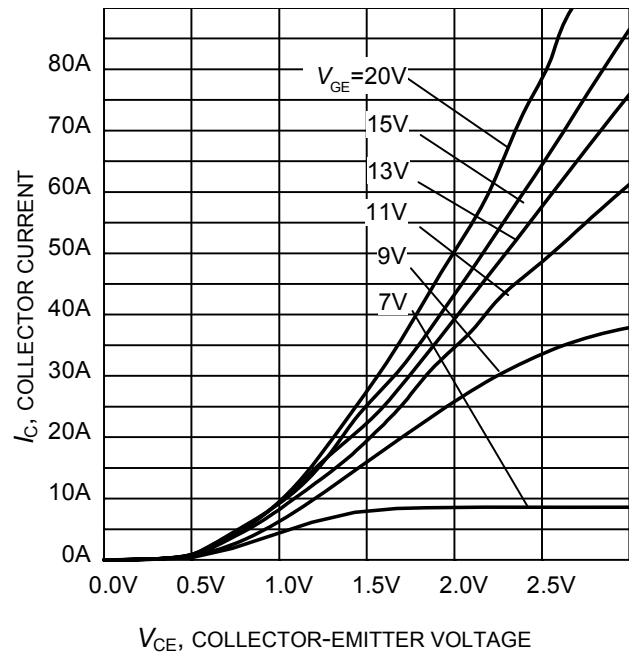
**Figure 3. Power dissipation as a function of case temperature**  
 $(T_j \leq 175^\circ\text{C})$



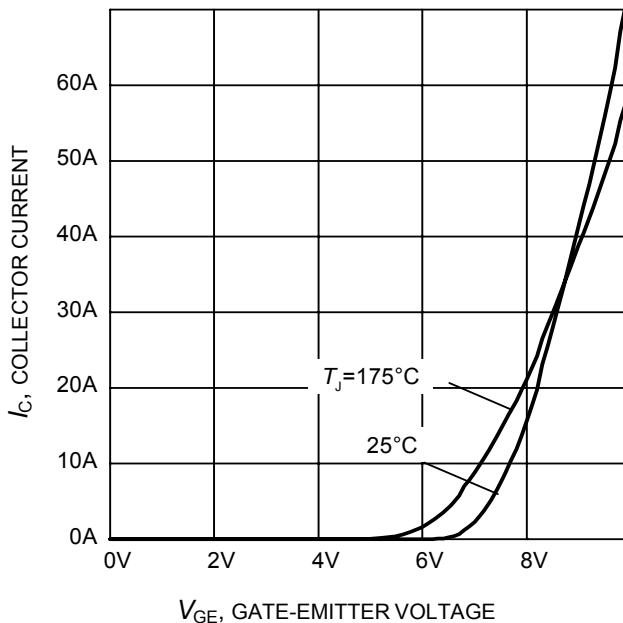
**Figure 4. Collector current as a function of case temperature**  
 $(V_{GE} \geq 15\text{V}, T_j \leq 175^\circ\text{C})$



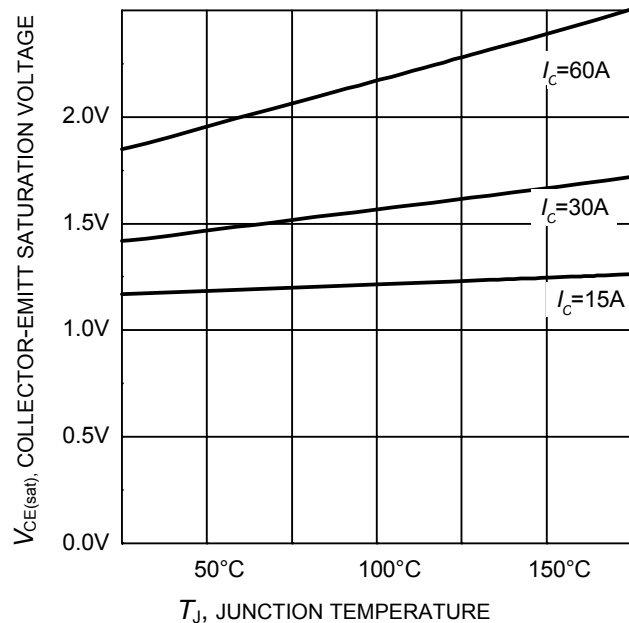
**Figure 5. Typical output characteristic**  
( $T_j = 25^\circ\text{C}$ )



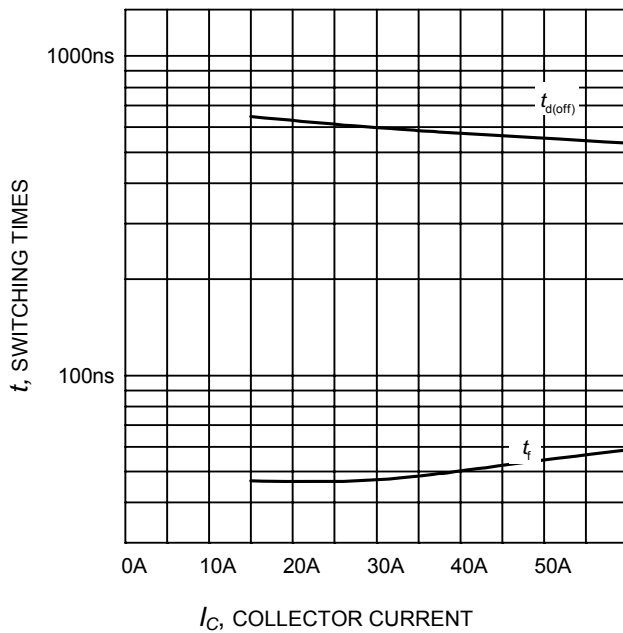
**Figure 6. Typical output characteristic**  
( $T_j = 175^\circ\text{C}$ )



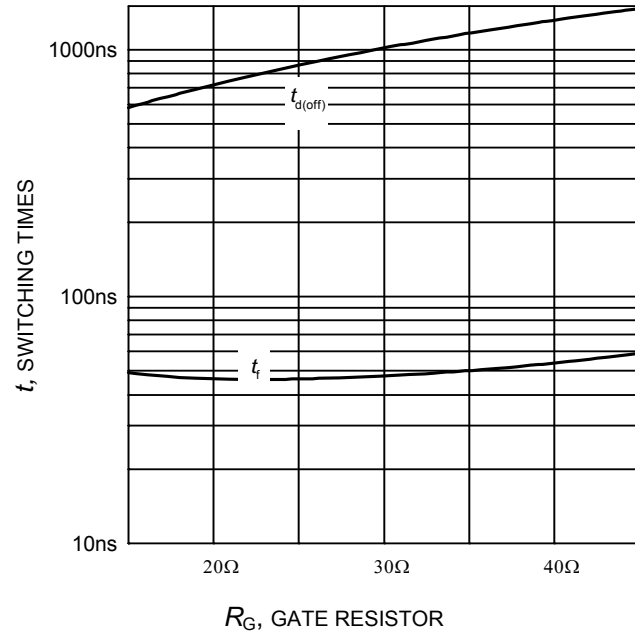
**Figure 7. Typical transfer characteristic**  
( $V_{CE} = 20\text{V}$ )



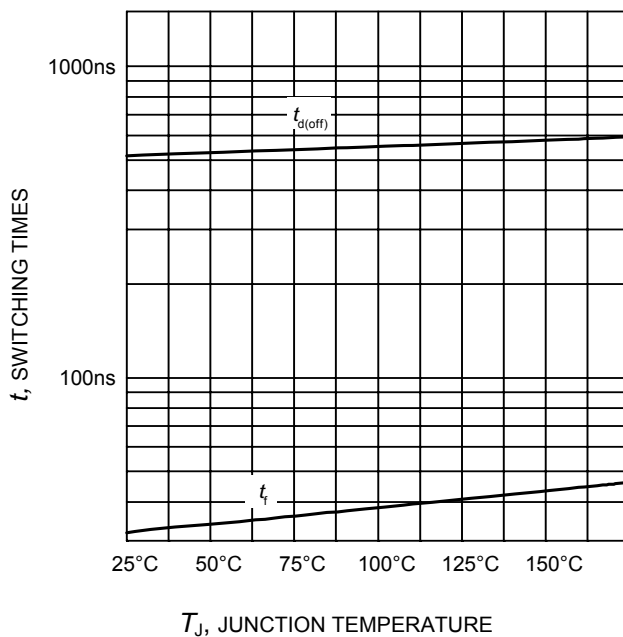
**Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE} = 15\text{V}$ )



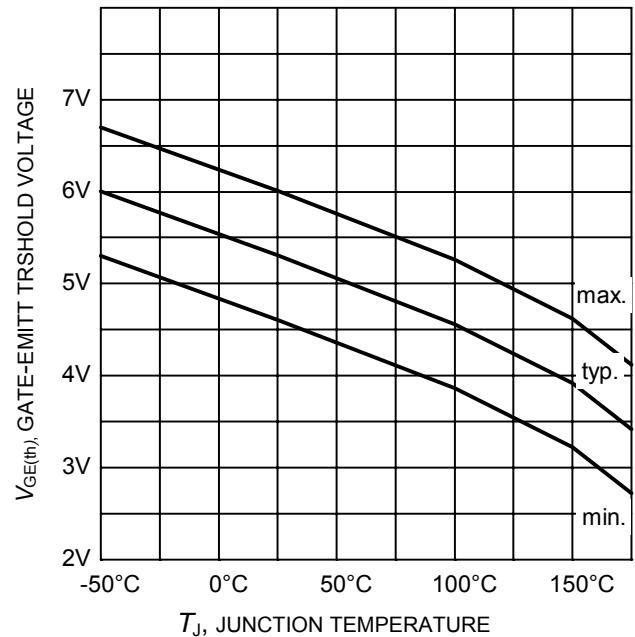
**Figure 9. Typical switching times as a function of collector current**  
(inductive load,  $T_J=175^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $R_G=15\Omega$ , Dynamic test circuit in Figure E)



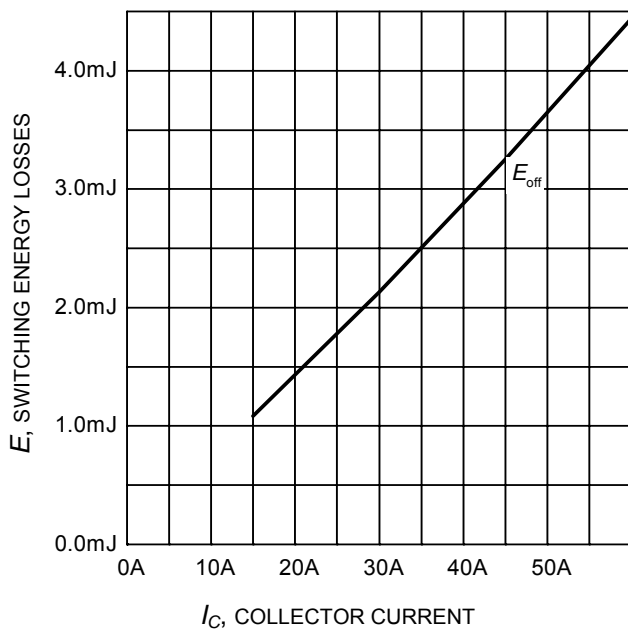
**Figure 10. Typical switching times as a function of gate resistor**  
(inductive load,  $T_J=175^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=30\text{A}$ , Dynamic test circuit in Figure E)



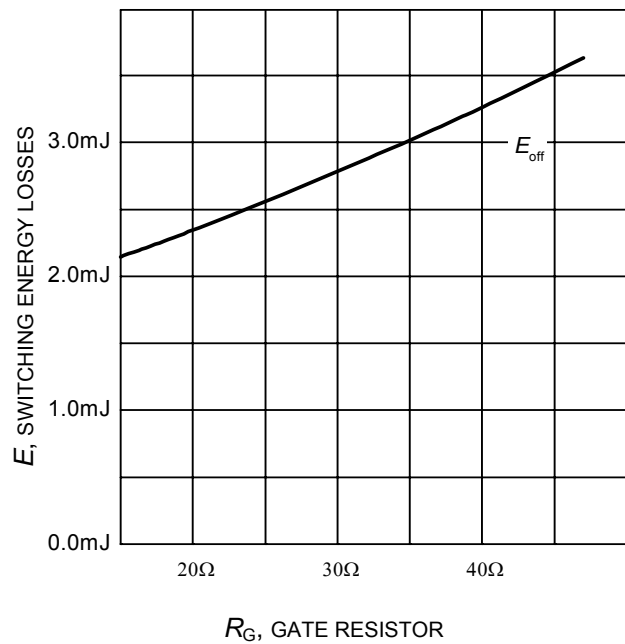
**Figure 11. Typical switching times as a function of junction temperature**  
(inductive load,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=30\text{A}$ ,  $R_G=15\Omega$ , Dynamic test circuit in Figure E)



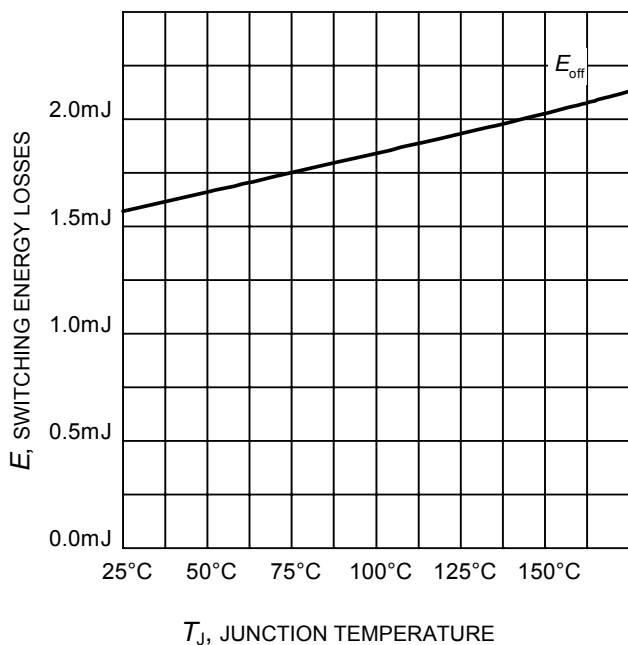
**Figure 12. Gate-emitter threshold voltage as a function of junction temperature**  
( $I_C = 0.7\text{mA}$ )



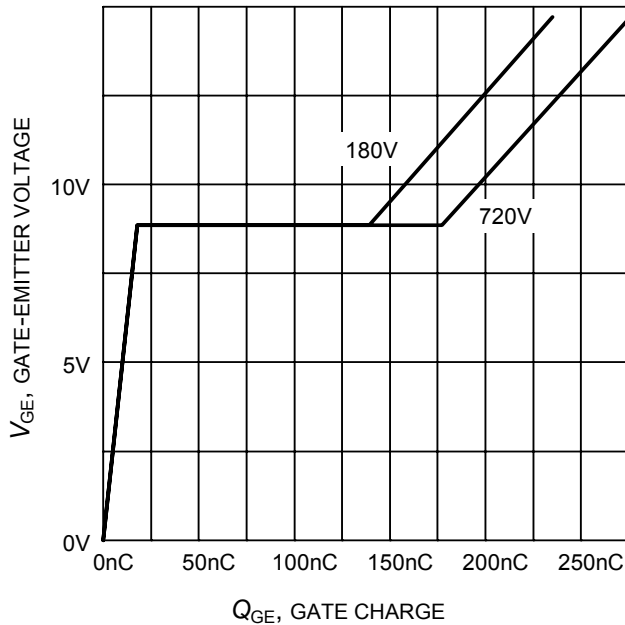
**Figure 13. Typical switching energy losses as a function of collector current**  
(inductive load,  $T_J=175^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $R_G=15\Omega$ , Dynamic test circuit in Figure E)



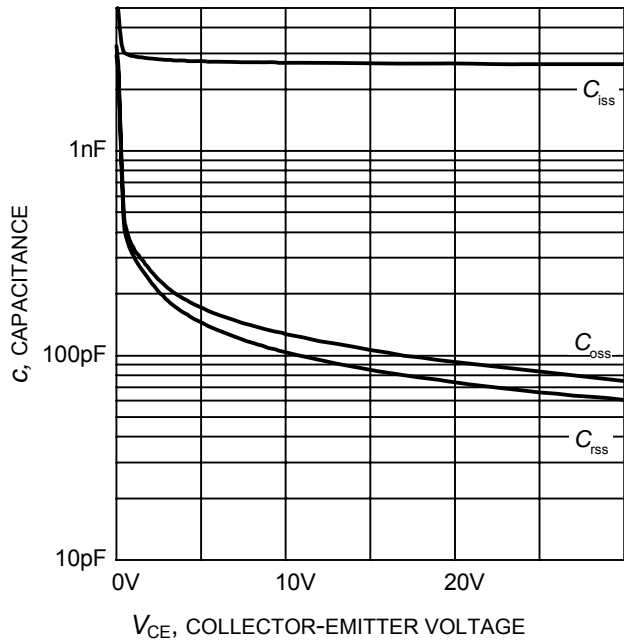
**Figure 14. Typical switching energy losses as a function of gate resistor**  
(inductive load,  $T_J=175^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=30\text{A}$ , Dynamic test circuit in Figure E)



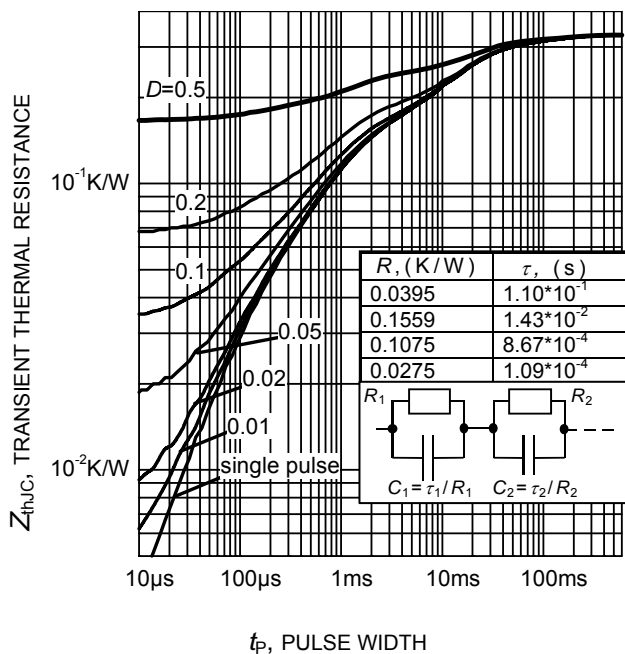
**Figure 15. Typical switching energy losses as a function of junction temperature**  
(inductive load,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=30\text{A}$ ,  $R_G=15\Omega$ , Dynamic test circuit in Figure E)



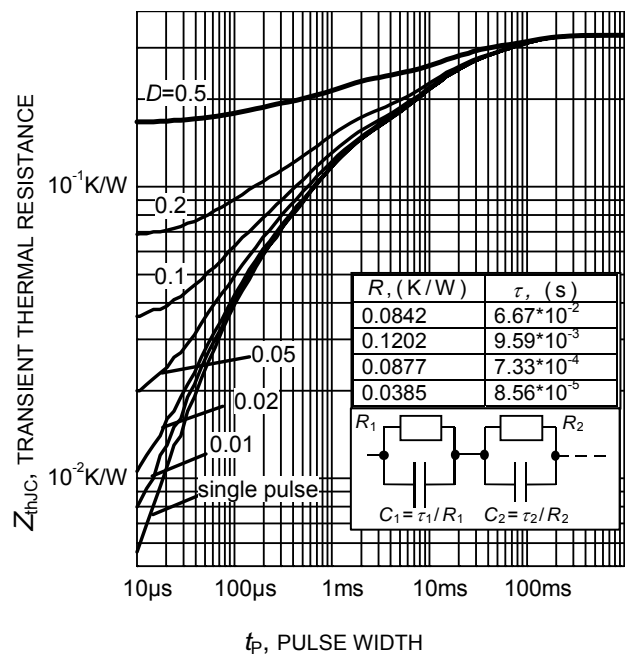
**Figure 16. Typical gate charge**  
( $I_C = 30\text{ A}$ )



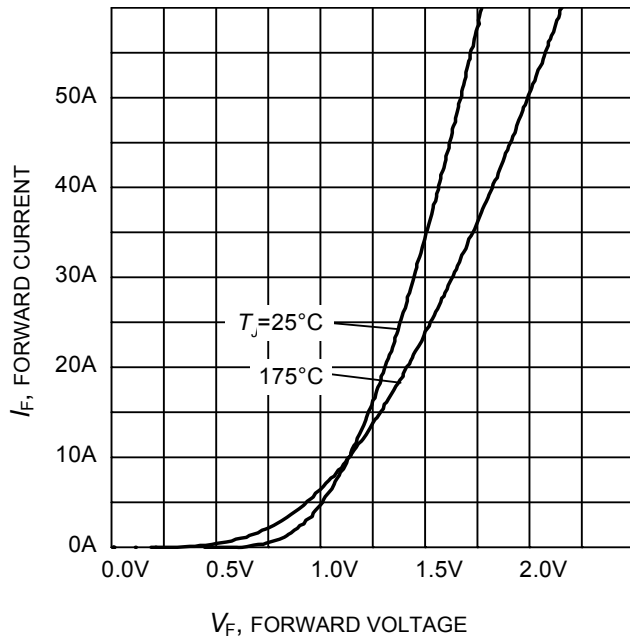
**Figure 17. Typical capacitance as a function of collector-emitter voltage**  
( $V_{GE} = 0\text{ V}$ ,  $f = 1\text{ MHz}$ )



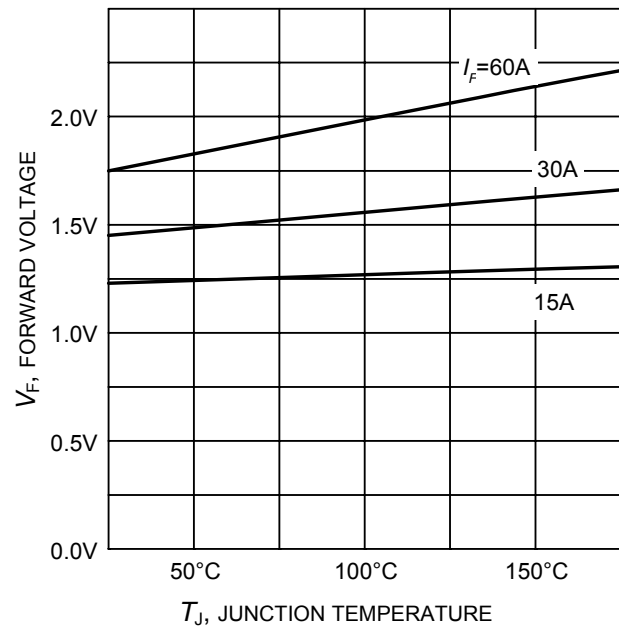
**Figure 18. IGBT transient thermal resistance**  
( $D = t_p / T$ )



**Figure 19. Typical Diode transient thermal impedance as a function of pulse width**  
( $D = t_p / T$ )



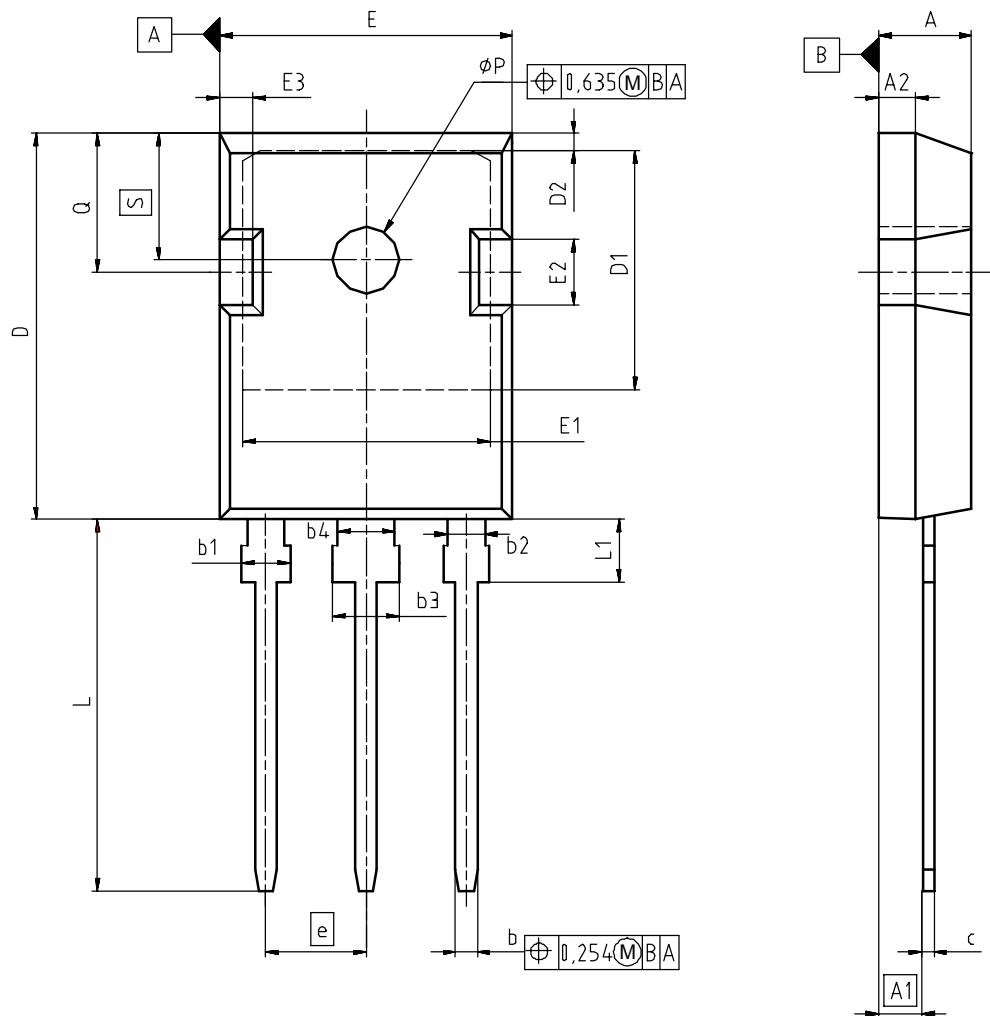
**Figure 20. Typical diode forward current as a function of forward voltage**



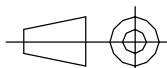
**Figure 21. Typical diode forward voltage as a function of junction temperature**



### PG-TO247-3



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.16	0.193	0.203
A1	2.27	2.53	0.089	0.099
A2	1.85	2.11	0.073	0.083
b	1.07	1.33	0.042	0.052
b1	1.90	2.41	0.075	0.095
b2	1.90	2.16	0.075	0.085
b3	2.87	3.38	0.113	0.133
b4	2.87	3.13	0.113	0.123
c	0.55	0.68	0.022	0.027
D	20.82	21.10	0.820	0.831
D1	16.25	17.65	0.640	0.695
D2	1.05	1.35	0.041	0.053
E	15.70	16.03	0.618	0.631
E1	13.10	14.15	0.516	0.557
E2	3.68	5.10	0.145	0.201
E3	1.68	2.60	0.066	0.102
e	5.44		0.214	
N	3		3	
L	19.80	20.31	0.780	0.799
L1	4.17	4.47	0.164	0.176
$\phi P$	3.50	3.70	0.138	0.146
Q	5.49	6.00	0.216	0.236
S	6.04	6.30	0.238	0.248

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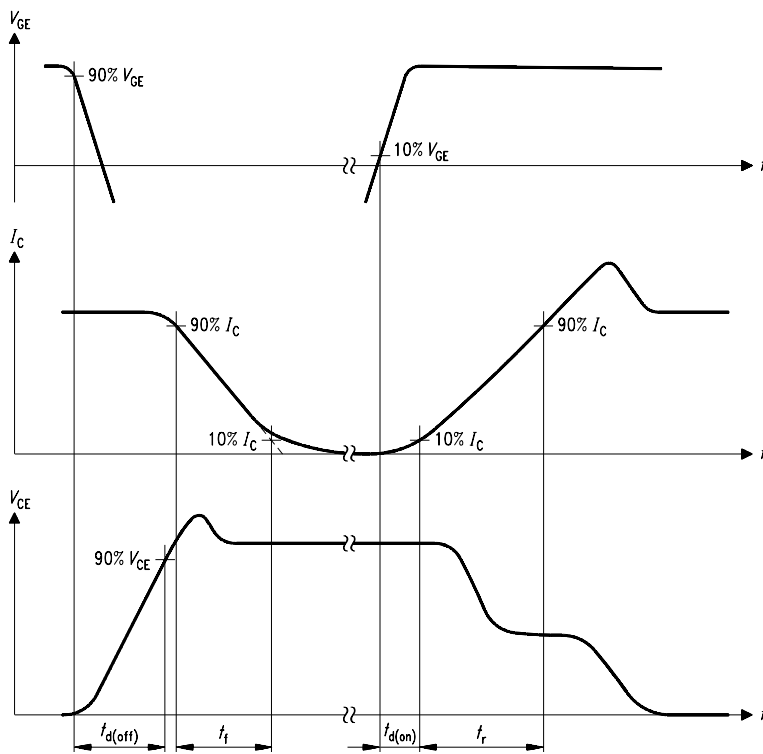


Figure A. Definition of switching times

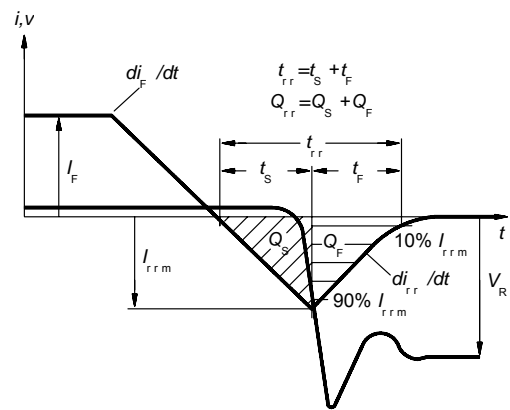


Figure C. Definition of diodes switching characteristics

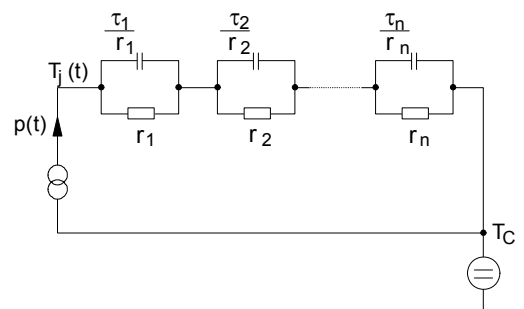


Figure D. Thermal equivalent circuit

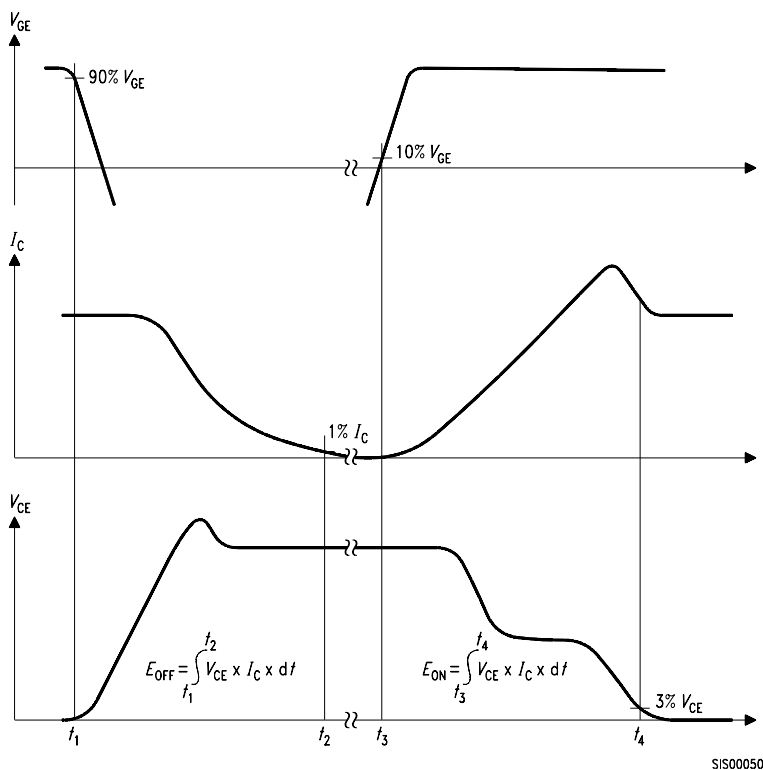


Figure B. Definition of switching losses

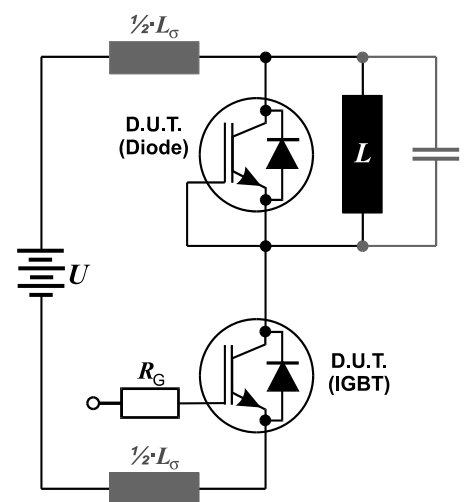


Figure E. Dynamic test circuit

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